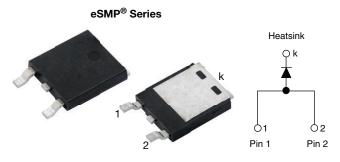


Hyperfast Rectifier, 8 A FRED Pt®



SlimDPAK (TO-252AE)

PRODUCT SUMMARY				
Package	SlimDPAK (TO-252AE)			
I _{F(AV)}	8 A			
V_{R}	600 V			
V _F at I _F	1.4 V			
t _{rr} (typ.)	14 ns			
T _J max.	175 °C			
Diode variation	Single			

FEATURES





• For PFC CCM operation

· Low forward voltage drop, low power losses

Low leakage current

ROHS COMPLIANT HALOGEN FREE

 Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

• Meets JESD 201 class 2 whisker test

 Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

These devices are intended for use in PFC boost stage in the AC/DC section of SMPS inverters, or as freewheeling diodes. Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

MECHANICAL DATA

Case: SlimDPAK

Molding compound meets UL 94 V-0 flammability rating

Base PN/-M3 - halogen-free, RoHS-compliant

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Peak repetitive reverse voltage	V_{RRM}		600	V	
Average rectified forward current	I _{F(AV)}	T _C = 140 °C	8	۸	
Non-repetitive peak surge current	I _{FSM}	T _J = 25 °C	80	A	
Operating junction and storage temperatures	T _J , T _{Stg}		-55 to +175	°C	

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Breakdown voltage, blocking voltage	V _{BR} , V _R	Ι _R = 100 μΑ	600	-	-		
Forward voltage V _F	V	I _F = 8 A	-	2.3	3.0	V	
	I _F = 8 A, T _J = 150 °C	-	1.4	1.8			
Reverse leakage current		V _R = V _R rated	-	-	20		
	I _R	T _J = 150 °C, V _R = V _R rated	-	-	500	μA	
Junction capacitance	C _T	V _R = 600 V	-	12	-	pF	



DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
		$I_F = 1 \text{ A}$, $dI_F/dt = 50 \text{ A/}\mu\text{s}$, $V_R = 30 \text{ V}$		-	20	-	
		$I_F = 1 \text{ A}, dI_F/dt = 100 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$		-	14	-	
Reverse recovery time	t _{rr}	$I_F = 0.5 \text{ A}, I_R = 1 \text{ A}, I_{RR} = 0.25 \text{ A}$		-	-	18	ns
		T _J = 25 °C	I _F = 8 A dI _F /dt = 500 A/μs	-	20	-	
		T _J = 125 °C		-	54	-	
Peak recovery current	I _{RRM}	T _J = 25 °C		-	4.0	-	Α
		T _J = 125 °C	$V_{R} = 400 \text{ V}$	-	8.0	-	A
Poverse recovery charge	0	T _J = 25 °C		-	60	-	nC
Reverse recovery charge	Q _{rr}	T _J = 125 °C		-	200	-	110

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	T _J , T _{Stg}		-55	-	175	°C
Thermal resistance, junction to case	R _{thJC}		-	-	2.2	°C/W
Marking device		Case style SlimDPAK (TO-252AE)	8EVX06			

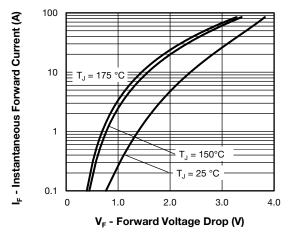


Fig. 1 - Typical Forward Voltage Drop Characteristics

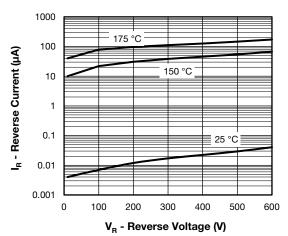


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage



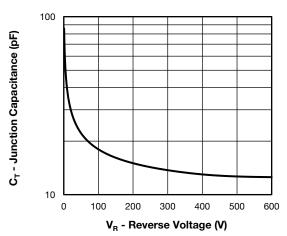


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

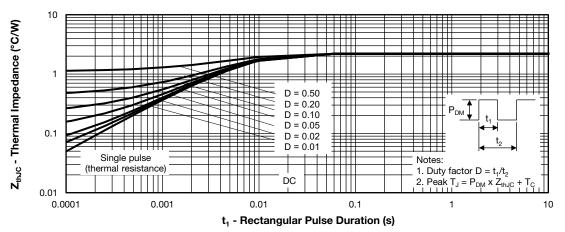


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

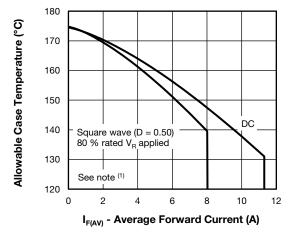


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

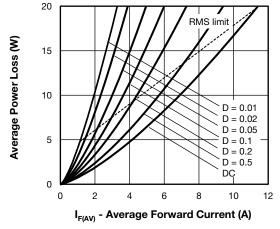


Fig. 6 - Forward Power Loss Characteristics

Note

Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$; Pd = forward power loss = $I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6); Pd_{REV} = inverse power loss = $V_{R1} \times I_R$ (1 - D); I_R at V_{R1} = rated V_R



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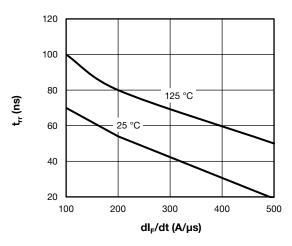


Fig. 7 - Typical Reverse Recovery Time vs. dl_F/dt

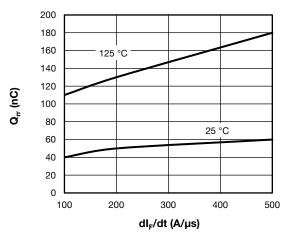
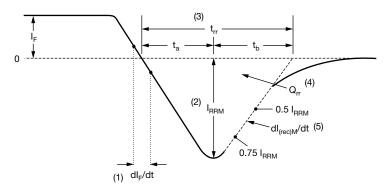


Fig. 8 - Typical Stored Charge vs. dl_F/dt



- (1) dl_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) $\rm t_{rr}$ reverse recovery time measured from zero crossing point of negative going $\rm I_F$ to point where a line passing through 0.75 $\rm I_{RRM}$ and 0.50 $\rm I_{RRM}$ extrapolated to zero current.
- (4) \mathbf{Q}_{rr} area under curve defined by \mathbf{t}_{rr} and \mathbf{I}_{RRM}

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

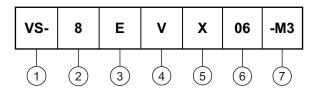
(5) dl_{(rec)M}/dt - peak rate of change of current during t_b portion of t_{rr}

Fig. 9 - Reverse Recovery Waveform and Definitions



ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Current rating (8 = 8 A)

3 - Circuit configuration:

E = single die

4 - V = SlimDPAK

Frocess type:

X = hyperfast rectifier

6 - Voltage code (06 = 600 V)

7 - Environmental digit:

M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

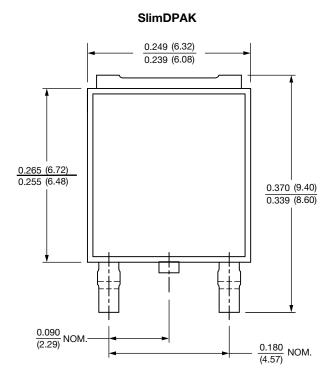
ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	PACKAGING DESCRIPTION		
VS-8EVX06-M3/I	0.20	1	4500	13"diameter plastic tape and reel		

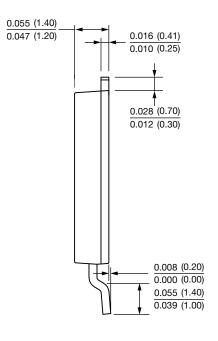
LINKS TO RELATED DOCUMENTS				
Dimensions www.vishay.com/doc?96081				
Part marking information <u>www.vishay.com/doc?96085</u>				
Packaging information	www.vishay.com/doc?88869			



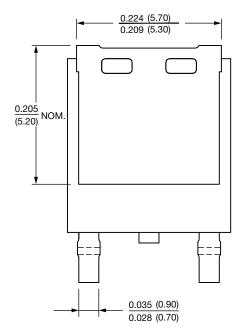
SlimDPAK

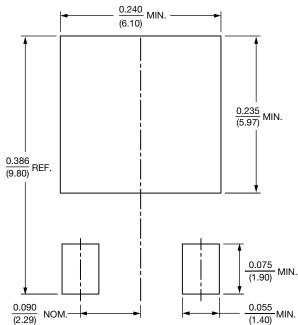
DIMENSIONS in inches (millimeters)





Mounting Pad Layout







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Vishay

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